# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6064977

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HUILIN XU	04/14/2020
TINGFANG JI	04/10/2020
ALEXANDROS MANOLAKOS	04/07/2020
WANSHI CHEN	04/06/2020

## **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

#### **PROPERTY NUMBERS Total: 2**

Property Type	Number		
Application Number:	16735051		
PCT Number:	GR2019100019		

## **CORRESPONDENCE DATA**

**Fax Number:** (303)473-2720

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 303-473-2700

**Email:** bmsoares@hollandhart.com

Correspondent Name: MICHAEL DRAPKIN Address Line 1: P.O. BOX 11583

Address Line 4: SALT LAKE CITY, UTAH 84147

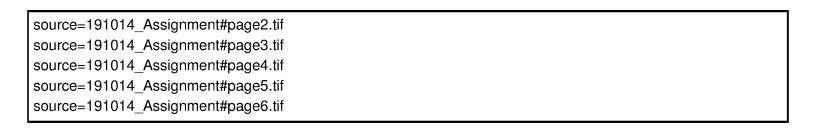
ATTORNEY DOCKET NUMBER:	PR275GR.US (103038.1468)
NAME OF SUBMITTER:	MICHAEL L. DRAPKIN
SIGNATURE:	/Michael L. Drapkin/
DATE SIGNED:	04/16/2020

**Total Attachments: 6** 

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PATENT REEL: 052418 FRAME: 0971

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#### ASSIGNMENT

## WHEREAS, WE,

- 1. Huilin XU, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714.
- 2. Tingfang JI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
- 3. Alexandros MANOLAKOS, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
- 4. Wanshi CHEN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **CROSS-LINK INTERFERENCE MEASUREMENT TRANSMISSION SCHEMES** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that I/WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 16/735,051 filed January 6, 2020, Qualcomm Reference No. 191014, and all provisional applications relating thereto, together with Greece Provisional Application No. 20190100019 filed January 11, 2019, Qualcomm Reference No. 191014GR1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY coverant that WE will not execute any writing or do any act whatevever conflicting with these present.

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PATENT QUALCOMM Ref. No. 191014 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

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	LOCATION	DATE	Huitin XV
Done at 5	Nago, CA, on LOCATION	4/10/2020	- Tron
	LOCATION	DATE	l'ingfang Jl
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Done at	, on	<u> </u>	~
	LOCATION	DATE	Alexandros MANOLAROS
9			
Done at	, con		
	LOCATION	DATE	Wanshi CHEN

PATENT QUALCOMM Ref. No. 191014 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on	
	LOCATION	DATE	Huilin XU
Done at		, on	
	LOCATION	DATE	Tinglang JI
Done at	San Diejo	, on <u>04/04/7020</u> DATE	Adexandros MANOLAKOS
Done at	LOCATION	, on	Wanshi CHEN

PATENT QUALCOMM Ref. No. 191014 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		on	
	LOCATION	DATE	Huilie XU
Done at _		on	
	LOCATION	DATE	Tingfang JI
Done at _			
	LOCATION	DATE	Alexandros MANOLAKOS
(	7 N.,	<b>//</b>	
Jone at	San Wife	on 4/6/2000	
	LOCATION	DATÉ	Wanshi CHEN

PATENT REEL: 052418 FRAME: 0978

**RECORDED: 04/16/2020**